Pending

Abandoned

DECLARATION FOR U.S. PATENT APPLICATION

As a below named inventor, I hereby declare that:

(Application Serial No.)

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled JUNCTION CIRCUIT FOR AUXILIARY DEVICE MODULE AND AUXILIARY DEVICE MODULE the specification of which is attached hereto unless the following is checked _ as United States Application Number ____ or PCT International Application Number ___ was amended on ____ (if applicable). I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claim(s), as amended by any amendment referred above. I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56. I hereby claim foreign priority benefits under Title 35, United States Code, § 119 (a) - (d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application for which priority is claimed. Priority Claimed (List prior foreign applications. See 09/Mar./2001 🛚 Yes 🗌 No note A below) (Day/Month/Year Filed) ☐ Yes ☐ No (Number) (Country) (Day/Month/Year Filed) ☐ Yes ☐ No (Number) (Country) (Day/Month/Year Filed) 🛚 Yes 🔲 No (Number) (Country) (Day/Month/Year Filed) (See note B below) See attached list for additional prior foreign applications I hereby claim the benefit under Title 35, United States Code, 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, ' 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application. Status (List prior U.S. Applications) ☐ Patented ☐ Pending Abandoned (Application Serial No.) (Filing Date) Patented 🗍 Pending

Abandoned (Application Serial No.) (Filing Date) Patented

(Filing Date)

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

(See note C)		first inventor (given name, family name)	ISAO KAMEYAMA
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Apply Hash days	Full name of second inventor (given name, family name)		
	Inventor's signature		Date
	Residence		Citizenship
	Post Office Address		
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	Full name of third in	ventor (given name, family name)	
<u>.</u>	Inventor's signature		Date
than that there to	Residence		Citizenship
	Post Office Address		
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		•	
	Full name of fourth inventor (given name, family name)		
	Inventor's signature	•	Date
	Residence		Citizenship
	Post Office Address		
	Full name of fifth inventor (given name, family name)		
	Inventor's signature	, ,	Date
	Residence		Citizenship
	Post Office Address		
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